



PCB Layout(T=2.0)

PART EDGE

# 深圳市精拓金电子有限公司

产品图  
PRODUCT CHART DWG

公差一览表		公差一览表	
TOLERANCE	UNLESS OTHERWISE	公差	OTHERWISE
X	±0.35	X	±5°
X	±0.30	X	±2°
XX	±0.20	XX	±1°
XXX	±0.10	XXX	±0.5°

单位	MM	制图	制图料号	产品名称	角法	版本
UNITS	MM	DRAWING	Gavin	USB AF 90° /SIDE/DIP	☉	AD
比例	1:1	审核	郭治富	PRODUCT NO	☞	VER
日期	2016-10-20	核准	黄国荣	VIEW	☛	
DATE	2016-10-20	APPRO				

**NOTES:**

- MATERIALS AND FINISHES:**  
 HOUSING MATERIAL: LCP R846 UL94V-0 HR,  
 PLY MATERIAL: C7035 TN-04 T=0.25mm  
 CONTACT AREA: PLATING Au 30μ Min, Ni 80μ Min  
 SOLDER TAIL: MATTE TIN 180μ Min.  
 SHELL MATERIAL: PBO, BRONZE T=0.30mm  
 PLATED Ni 50μ Min  
 BACK SHELL MATERIAL: SUS304 T=0.20mm
- ELECTRICAL CHARACTERISTICS:**  
 CONTACT RESISTANCE: 30mΩ Max.  
 DIELECTRIC WITHSTANDING VOLTAGE: AC 500V R.M.S.  
 INSULATION RESISTANCE: 1000MΩ MIN.
- MECHANICAL CHARACTERISTICS:**  
 CONTACT INSERTION FORCE: 35 N MAX.  
 CONTACT SEPARATION FORCE: 10 N MIN(AFTER CYCLE 1500).  
 MATERIAL MUST FULFILL GBT4-11 SALCOMP HAZARDOUS  
 SUBSTANCES MANAGEMENT STANDARD LATEST VERSION.

MAPX

MODIFICATION

DATE

